

IN THE CLAIMS:

Please amend the claims 1, 4-6, 8, 9 and 11-13 as follows:

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disclosed
1. A paste pattern forming method wherein a drawing pattern is formed on a paste-applied body with a linearly drawn paste line such that no bubbles are left in joining surfaces when the joining surfaces are bonded to each other.

4. A paste pattern forming method according to claim 2, wherein the paste line is drawn while moving any of said paste-applied body, said nozzle and said paste.

5. A paste pattern forming method according to claim 1 or 2, wherein said paste-applied body is a lead frame, and said paste is an adhesive for die bonding.

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6. A paste pattern forming method according to claim 1 or 2, wherein said drawing pattern is a figure made up of a plurality of segment lines.

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A
8. A paste pattern forming method according to claim 1 or 2, wherein said drawing pattern is a figure including an enclosed shape.

9. A paste pattern forming method according to claim 6, wherein at least one segment line is formed of two drawn lines.

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B₆ >

11. A paste pattern forming method according to claim 1 or 2, wherein said drawing pattern is formed such that the total number of start and end points of drawn lines is not larger than the number of segment lines.

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12. A paste pattern forming method according to claim 1 or 2, wherein said drawing pattern is formed such that the start and end points of drawn lines are positioned other than the ends of said drawing pattern.

13. A paste pattern forming method according to claim 1 or 2, wherein said drawing pattern is formed with a minimum number of points at which the drawn lines are returned in a drawing process.

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